Octal 3-State Noninverting Buffer/Line Driver/ Line Receiver with LSTTL-Compatible Inputs

High-Performance Silicon-Gate CMOS

The MC74HCT241A is identical in pinout to the LS241. This device may be used as a level converter for interfacing TTL or NMOS outputs to High–Speed CMOS inputs. The HCT241A is an octal noninverting buffer/line driver/line receiver designed to be used with 3–state memory address drivers, clock drivers, and other bus–oriented systems. The device has non–inverted outputs and two output enables. Enable A is active–low and Enable B is active–high.

The HCT241A is similar in function to the HCT244. See also HCT240.

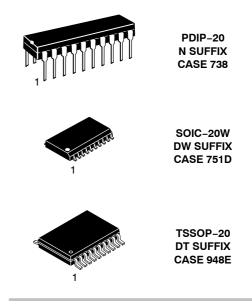
Features

- Output Drive Capability: 15 LSTTL Loads
- TTL/NMOS Compatible Input Levels
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 4.5 to 5.5 V
- Low Input Current: 1.0 µA
- In Compliance with the Requirements Defined by JEDEC Standard No. 7A
- Chip Complexity: 118 FETs or 29.5 Equivalent Gates
- Pb-Free Packages are Available*



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ORDERING INFORMATION

See detailed ordering, shipping information, and marking information in the package dimensions section on page 6 of this data sheet.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

LOGIC DIAGRAM A1 _2 <u>-18</u> YA1 <u>16</u> YA2 A2 ____ A3 <u>6</u> 14 YA3 A4 <u>8</u> <u>12</u> YA4 NONINVERTING DATA INPUTS B1 <u>11</u> <u>9</u> YB1 OUTPUTS B2 13 7 YB2 B3 <u>15</u> 5 YB3 B4 <u>17</u> 3 YB4 PIN 20 = V_{CC} PIN 10 = GND OUTPUT ENABLE A 1 ENABLES ENABLE B 19

PIN ASSIGNMENT

ENABLE A	1•	20	□ v _{cc}
A1 [2	19	ENABLE B
YB4 [3	18] YA1
A2 [4	17] B4
ҮВЗ [5	16] YA2
A3 [6	15] вз
YB2	7	14] YA3
A4 [8	13] B2
YB1	9	12] YA4
GND [10	11] B1

FUNCTION TABLE

Inpu	Output	
Enable A A		YA
L	L	L
L	н	н
н	X	Z

Inpu	Output	
Enable B B		YB
Н	L	L
н	н	Н
L	Х	Z

Z = high impedance X = don't care

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	– 0.5 to + 7.0	V
V _{in}	DC Input Voltage (Referenced to GND)	-0.5 to V_{CC} + 0.5	V
V _{out}	DC Output Voltage (Referenced to GND)	$-$ 0.5 to V_{CC} + 0.5	V
l _{in}	DC Input Current, per Pin	± 20	mA
I _{out}	DC Output Current, per Pin	± 35	mA
I _{CC}	DC Supply Current, V_{CC} and GND Pins	± 75	mA
P _D	Power Dissipation in Still Air, Plastic or Ceramic DIP† SOIC Package†	750 500	mW
T _{stg}	Storage Temperature	– 65 to + 150	°C
TL	Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP or SOIC Package) (Ceramic DIP)	260 300	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND $\leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

†Derating — Plastic DIP: – 10 mW/°C from 65° to 125°C Ceramic DIP: – 10 mW/°C from 100° to 125°C SOIC Package: – 7 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Max	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	4.5	5.5	V
V _{in} , V _{out}	DC Input Voltage, Output Voltage (Referenced to GND)	0	V _{CC}	V
T _A	Operating Temperature, All Package Types	- 55	+ 125	°C
t _r , t _f	Input Rise and Fall Time (Figure 1)	0	500	ns

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

				Gu	aranteed L	imit	
Symbol	Parameter	Test Conditions	V _{CC} V	– 55 to 25°C	≤ 85 °C	≤ 125°C	Unit
V _{IH}	Minimum High-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \ V \ or \ V_{CC} - 0.1 \ V \\ \left I_{out}\right \leq 20 \ \mu A \end{array}$	4.5 5.5	2 2	2 2	2 2	V
V _{IL}	Maximum Low-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \ V \ or \ V_{CC} - 0.1 \ V \\ \left I_{out}\right \leq 20 \ \mu A \end{array}$	4.5 5.5	0.8 0.8	0.8 0.8	0 8 0.8	V
V _{OH}	Minimum High-Level Output Voltage	$ V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \le 20 \ \mu A$	4.5 5.5	4.4 5.4	4.4 5.4	4.4 5.4	V
		$V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \le 6 \text{ mA}$	4.5	3.98	3.84	3.7	
V _{OL}	Maximum Low-Level Output Voltage	$V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \le 20 \ \mu A$	4.5 5.5	0.1 0.1	0.1 0.1	0.1 0.1	V
		$V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \le 6 \text{ mA}$	4.5	0.26	0.33	0.4	
l _{in}	Maximum Input Leakage Current	V _{in} = V _{CC} or GND	5.5	± 0.1	± 1.0	± 1.0	μA
I _{OZ}	Maximum Three-State Leakage Current	Output in High–Impedance State $V_{in} = V_{IL} \text{ or } V_{IH}$ $V_{out} = V_{CC} \text{ or GND}$	5.5	± 0.5	± 5.0	± 10	μA
I _{CC}	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0 \ \mu A$	5.5	4	40	160	μΑ
ΔI _{CC}	Additional Quiescent Supply Current	V_{in} = 2.4 V, Any One Input V_{in} = V _{CC} or GND, Other Inputs		≥ -55 °	C 25°	C to 125°C	
		$I_{out} = 0 \mu A$	5.5	2.9		2.4	mA

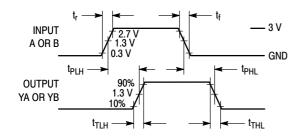
1. Total Supply Current = $I_{CC} + \Sigma \Delta I_{CC}$.

		G	Guaranteed Limit		
Symbol	Parameter	– 55 to 25°C	≤ 85 °C	≤ 125°C	Uni
t _{PLH} , t _{PHL}	Maximum Propagation Delay, A to YA or B to YB (Figures 1 and 3)	23	29	35	ns
t _{PLZ} , t _{PHZ}	Maximum Propagation Delay, Output Enable to YA or YB (Figures 2 and 4)	30	38	45	ns
t _{PZL} , t _{PZH}	Maximum Propagation Delay, Output Enable to YA or YB (Figures 2 and 4)	26	33	39	ns
t _{TLH} , t _{THL}	Maximum Output Transition Time, Any Output (Figures 1 and 3)	12	15	18	ns
C _{in}	Maximum Input Capacitance	10	10	10	pF
C _{out}	Maximum Three-State Output Capacitance (Output in High-Impedance State)	15	15	15	pF
		Typica	l@25°C, V _{CC}	; = 5.0 V	
C _{PD}	Power Dissipation Capacitance (Per Enabled Output)*		55		pF

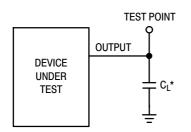
AC ELECTRICAL CHARACTERISTICS (V_{CC} = 5.0 V ± 10%, C_L = 50 pF, Input t_r = t_f = 6 ns)

* Used to determine the no-load dynamic power consumption: $P_D = \overline{C_{PD} V_{CC}^2 f} + I_{CC} V_{CC}$.

SWITCHING WAVEFORMS

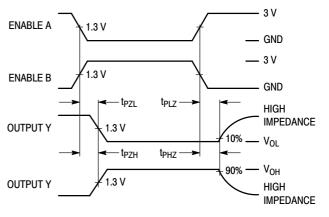




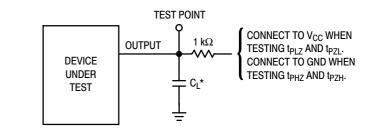


*Includes all probe and jig capacitance





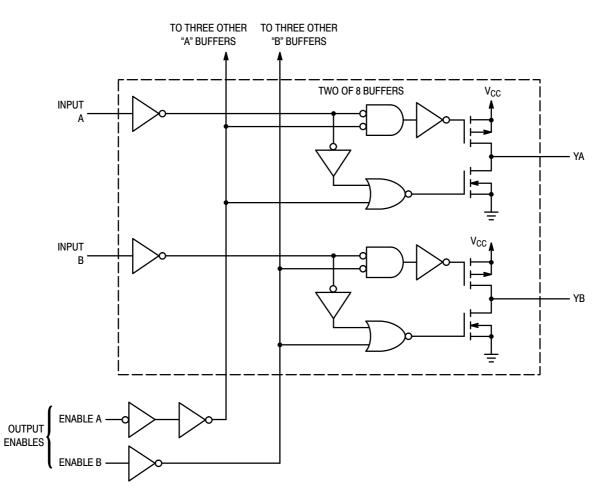




*Includes all probe and jig capacitance



LOGIC DETAIL



ORDERING INFORMATION

Device	Package	Shipping [†]
MC74HCT241ANG	PDIP-20 (Pb-Free)	18 Units / Rail
MC74HCT241ADWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74HCT241ADWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74HCT241ADTG	TSSOP-20*	75 Units / Rail
MC74HCT241ADTR2G	TSSOP-20*	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*These packages are inherently Pb-Free.

MARKING DIAGRAMS

PDIP-20

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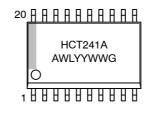
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MC74HCT241AN

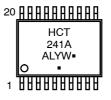
AWLYYWWG

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SOIC-20W



TSSOP-20



A = Assembly Location WL, L = Wafer Lot YY, Y = Year WW, W = Work Week G or = Pb-Free Package (Note: Microdot may be in either location)

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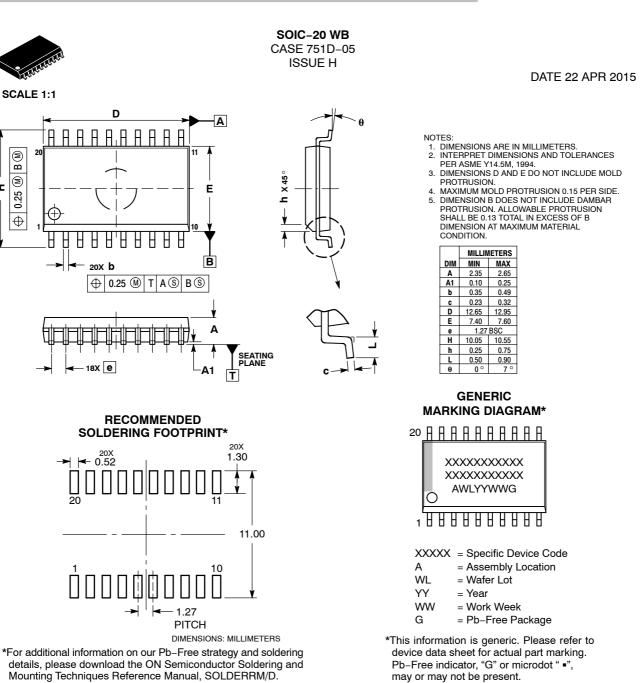
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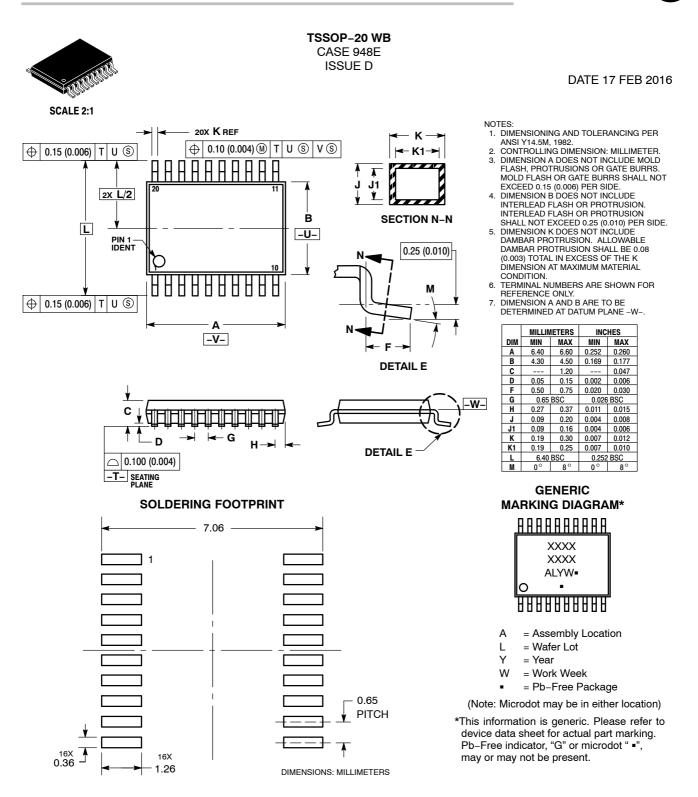
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